

QLSP1306Y 0603 0.6mm height Yellow LED





Product Outline:

This is the much smaller than lead frame type components,0603 package, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.

Features:

- Compatible with automatic placement equipment.
- RoHS compliant
- Compatible with infrared and vapor phase reflow solder process.
- Custom Bin available upon special request
- View angel typ. 120°
- 0.6mm Height

Application:

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Compliance and Certification:

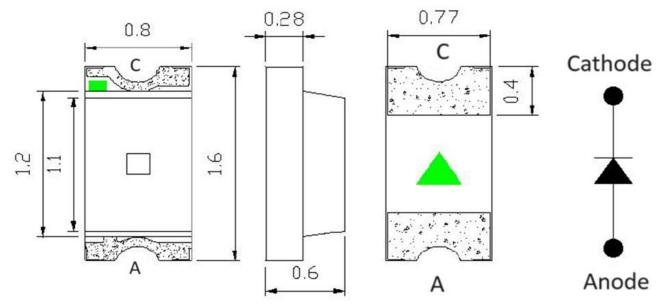






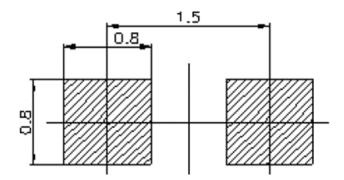


Mechanical Property: (Dimension)



- * All dimensions are in millimeters,
- * Tolerances are ± 0.10mm.

Recommended Solder footprint:



- * All dimensions are in millimeters.
- * Reflow soldering must not be performed more than twice.





Characteristics

■ Absolute Maximum Ratings

(Ta=25°C)

3				
Parameter	Symbol	Rating	Unit	
Reverse Voltage	V_{R}	5	V	
DC Forward Current	lf	25	mA	
Pulse Forward Current (Duty 1/10 @1KHz)	l _{FP}	60	mA	
Total Power Dissipation	Pd	55	mW	
Electrostatic Discharge (HBM)	ESD	150	V	
Storage Temperature	Tstg	-40 ~ 85	్లి	
Operation Temperature	Topr	-40 ~ 85	$^{\circ}$	
Soldering Temperature	Tsol	260 < 10 sec	${\mathbb C}$	

⁽¹⁾ Proper current rating must be observed to maintain junction temperature below maximum at all time

Electrical / Optical Characteristic

(Ta=25 oC)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	lv	71.5		285	mcd	
Peak Wavelength	λр		590		nm	IF=20mA
Dominant Wavelength	λd	585		595	nm	IF=ZUITIA
Forward Voltage	Vf	1.9		2.3	V	
View Angle	θ		120		deg	

- (1). Tolerance of Luminous Intensity: ±11%
- (2). Tolerance of Dominant Wavelength ±1nm
- (3). Tolerance of measurement: VF=+/- 0.1V





■ Groups Forward Voltage (V_F) Bin:

3	Condition			
Color	Code name	Low	High	unit
	Q	1.9	2.0	
	R	2.0	2.1	IF=20mA
Yellow	S	2.1	2.2	IF=20IIIA
	Т	2.2	2.3	

Dominant Wavelength Bin:

	Condition			
Color	Code name	Low	High	Unit
	DS	585	590	
Yellow	DT	590	595	IF=20mA

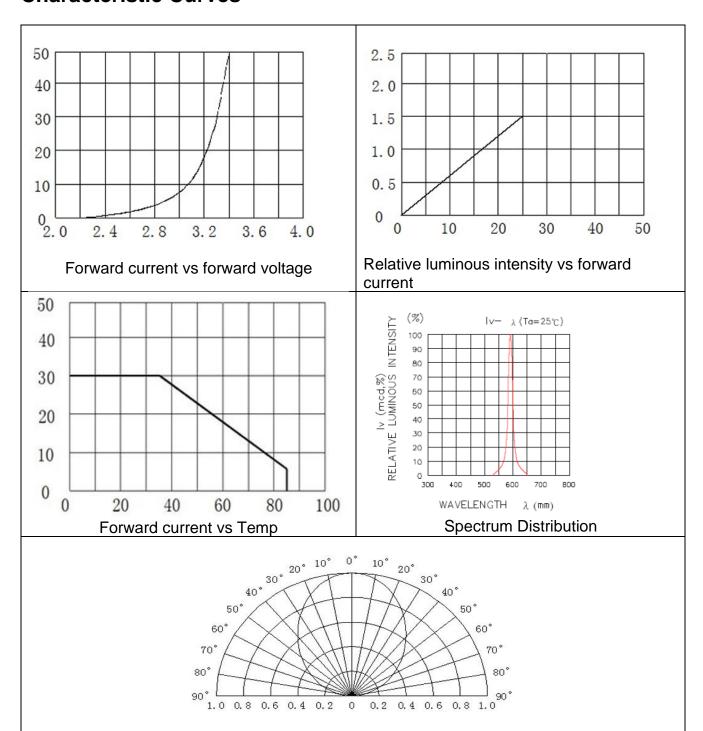
Brightness Bin:

	Condition			
Color	Code name	Low	High	Unit
Yellow	Q	71.5	112.5	IF=20mA
	R	112.5	180	
	S	180	285	





Characteristic Curves



Radiation pattern





■ Reliability test:

	Renability test.					
No	Item	Condition	Time/Cycle	Sample size		
1	Steady State Operating Life of Room Temperature	25℃ Operating	1000 Hrs	20 pcs		
2	Steady State Operating Life of Low Temperature -40°C	-40°C Operating	1000 Hrs	20 pcs		
3	Steady State Operating Life of Low Temperature $60^{\circ}\!$	60°C Operating	1000 Hrs	20 pcs		
4	Steady State Operating Life of Low Temperature 85 $^{\circ}\!\mathbb{C}$	85°C Operating	1000 Hrs	20 pcs		
5	Low temperature storage -40°C	-40°C Storage	1000 Hrs	20 pcs		
6	High temperature storage 100°C	100°C Storage	1000 Hrs	20 pcs		
7	Steady State Operating Life of High Humidity Heat 60°C 90%	60°C/90% Operating	1000 Hrs	20 pcs		
8	Steady State Pulse Operating Life Condition	25°C 10Hz duty=1/10 Operating	200 Cycle	20 pcs		
9	Resistance to soldering heat on PCB (JEDEC MSL3)	pre-store@60℃, 60%RH for 52hrs Tsld max.=260 10sec	3 Times	20 pcs		
10	Heat Cycle Test (JEDEC MRC)	25℃ ~65℃ ~-10℃ , 90%RH, 24hr/1cycle	10 Cycle	20 pcs		
11	Thermal shock	-40°C / 20minr~ 5minr~100°C /20min	300 Cycle	20 pcs		

■ Judgment Criteria:

Item	Symbol	Test Condition	Judgment Criteria
Forward Voltage	Vf	D . I	△Vf< 10%
Luminous Flux	lv	R : IF=20 mA	∆lv< 30%

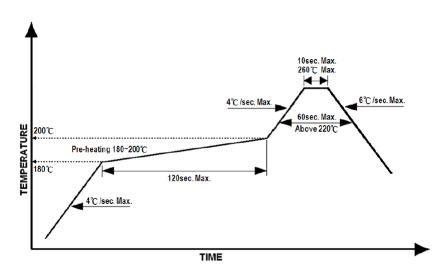




Solder Profile:

- -The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):
- 1. Operating temp.: Above 220 °C ,60 sec.
- 2. Peak temp.:260 °C Max.,10sec Max.
- 3. Reflow soldering should not be done more than two times.
- Never attempt next process until the component is cooled down to room temperature after reflow.
- 5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:

Lead-free Solder Profile



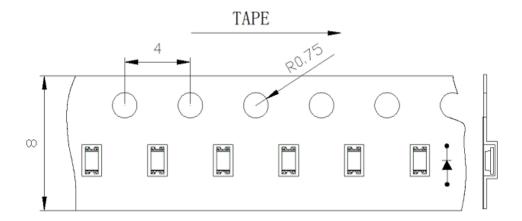
Reworking

- Rework should be completed within 5 seconds under 260°C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

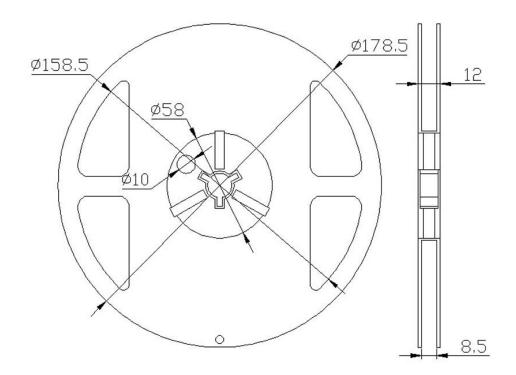




Taping & Packing:

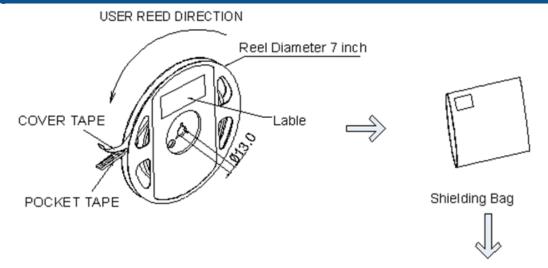


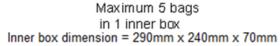
Unit: mm

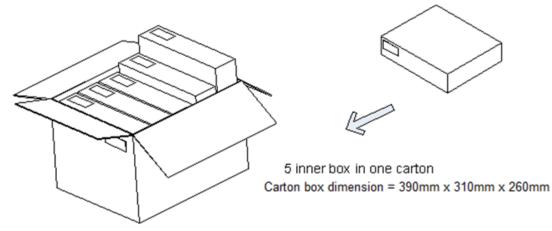






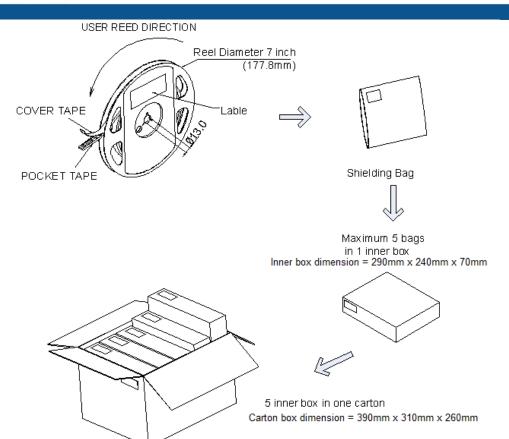




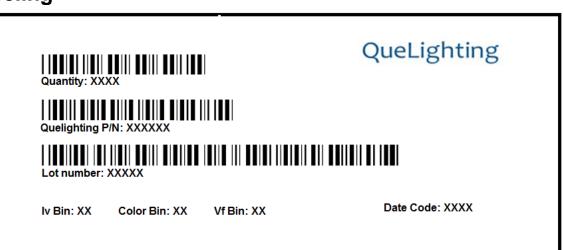








Labeling





Ordering Information:

Part #	Multiple Quantities	Quantity per Reel
QLSP1306Y		4000 pcs





Revision History:

Revision Date:	Changes:	Version #:
03-13-2023	Initial release	1.0

